

| Filename: PMP2587REVA_bom.xls | | | | | | |
|-------------------------------|--------|------------|--|------------------|-------------|-----------|
| Date: 02/22/2008 | | | | | | |
| PMP2587REVA BOM | | | | | | |
| COUNT | RefDes | Value | Description | Size | Part Number | Mfr |
| 4 | C1 | 10uF | Capacitor, Ceramic, 10-uF, 25-V, X5R, 15% | 1210 | Std | TDK |
| | C2 | 10uF | Capacitor, Ceramic, 10-uF, 25-V, X5R, 15% | 1210 | Std | TDK |
| | C3 | 10uF | Capacitor, Ceramic, 10-uF, 25-V, X5R, 15% | 1210 | Std | TDK |
| 1 | C4 | OPEN | Capacitor, Aluminum, 330-µF, 35-V, 20% | 0.457 x 0.406 | EEVFK1V331P | Panasonic |
| 1 | C5 | 2.2nF | Capacitor, Ceramic, 2.2nF, 50-V, X7R, 10% | 0603 | Std | Std |
| 1 | C6 | 100nF | Capacitor, Ceramic, 0.1-uF, 50-V, X7R, 15% | 0603 | Std | TDK |
| 1 | C7 | 68pF | Capacitor, Ceramic, 68-pF, 50-V, X7R, 15% | 0603 | Std | TDK |
| 1 | C8 | OPEN | Capacitor, Ceramic, 10-uF, 25-V, X5R, 15% | 1210 | Std | TDK |
| 1 | C9 | 470pF | Capacitor, Ceramic, 470-pF, 50-V, X7R, 15% | 0603 | Std | TDK |
| | C10 | 10uF | Capacitor, Ceramic, 10-uF, 25-V, X5R, 15% | 1210 | Std | TDK |
| 1 | C11 | OPEN | Capacitor, Ceramic, 4700-pF, 50-V, X7R, 15% | 0603 | Std | TDK |
| 1 | C12 | OPEN | Capacitor, Ceramic, 470-pF, 50-V, X7R, 15% | 0603 | Std | TDK |
| 1 | C13 | 33nF | Capacitor, Ceramic, 33-pF, 50-V, X7R, 15% | 0603 | Std | TDK |
| 1 | C14 | 100n | Ceramic, 25V | 0603 | std | std |
| 1 | C15 | 1u | Ceramic, 25V | 0603 | std | std |
| 1 | C16 | 150n | Ceramic, 25V | 0603 | std | std |
| 1 | C17 | OPEN | Ceramic, 100nF, 25V | 0603 | std | std |
| 1 | C18 | 33nF | Capacitor, Ceramic, 33nF, 50-V, X7R, 10% | 0603 | Std | Std |
| 1 | D4 | OPEN | Diode, Schottky, 3-A, 40-V | SMA | MBRA340 | Motorola |
| 1 | D5 | MBRD640 | Diode, Schottky, 6-A, 40-V | DPAK | STD | ONsemi |
| 1 | D6 | BZX84C5V1T | Diode, Zener, 5V1, 350-mW | SOT-23 | BZX84C5V1T | Diodes |
| 1 | D7 | BAV99 | Diode, Dual Ultra Fast, Series, 200-mA, 70-V | SOT23 | BAV99 | Fairchild |
| 2 | J1 | ED1514 | Terminal Block, 2-pin, 6-A, 3.5mm | 0.27 x 0.25 | ED1514 | OST |
| | J2 | ED1514 | Terminal Block, 2-pin, 6-A, 3.5mm | 0.27 x 0.25 | ED1514 | OST |
| 1 | J3 | PTC36DAAN | Header, 2x3-pin, 100mil spacing (36-pin strip) | 0.20 inch x 0.30 | PTC36DAAN | Sullins |

| | | | | | | |
|---|-----|-----------|---|--------------------|-----------------|-----------|
| 1 | J4 | PTC36SAAN | Header, 3-pin, 100mil spacing, (36-pin strip) | 0.100 inch x 3 | std | std |
| 1 | L1 | 2.2uH | Inductor, SMT, 2.2uH, 11.4A, 14milliohm | 0.484 x 0.484 inch | MSS1260-xxxxX_ | Coilcraft |
| 1 | L2 | OPEN | Inductor, SMT, 22uH, 1.3A, 82milliohm | 0.287 x 0.287 inch | MSS7341-xxxX_ | Coilcraft |
| 1 | Q1 | OPEN | MOSFET, P-Ch, -40, 54mOhm, 2.7A | SOP-8 | Si4447DY | Vishay |
| 1 | Q2 | FDD4243 | MOSFET, P-ch, 40-V, 6.7-A | DPAK | FDD4243 | Fairchild |
| 1 | Q3 | FDV301N | MOSFET, Nch,25V, 220-mA, 5 ohms | SOT23 | FDV301N | Fairchild |
| 1 | R1 | 100K | Resistor, Chip, 127K-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R2 | 0.01 | Resistor, Chip, 0.01Ohm, 0.5W, 1% | 1206 | 2.35052E+11 | PHYCOMP |
| 1 | R3 | 1.0K | Resistor, Chip, 2.2-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R4 | 0 | Resistor, Chip, 0-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R5 | 1.2k | Resistor, Chip, 1/16W, 1% | 0603 | std | std |
| 1 | R6 | 25.5 | Resistor, Chip, 1/8W, 1% | 1206 | CRCW1206-xxxx-F | Vishay |
| 4 | R7 | 2 | Resistor, Chip, 1/4W, 5% | 1210 | Std | Std |
| | R8 | 2 | Resistor, Chip, 1/4W, 5% | 1210 | Std | Std |
| | R9 | 2 | Resistor, Chip, 1/4W, 5% | 1210 | Std | Std |
| | R10 | 2 | Resistor, Chip, 1/4W, 5% | 1210 | Std | Std |
| 2 | R11 | 2.2 | Resistor, Chip, 1/4W, 5% | 1210 | Std | Std |
| | R12 | 2.2 | Resistor, Chip, 1/4W, 5% | 1210 | Std | Std |
| 1 | R13 | OPEN | Resistor, Chip, 100K-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R14 | OPEN | Resistor, Chip, 30.1K-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R15 | 1.2k | Resistor, Chip, 1/8W, 5% | 1206 | CRCW1206-xxx-J | Vishay |
| 1 | R16 | 1K | Resistor, Chip, 100K-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R17 | 49.9 | Resistor, Chip, 49.9-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 2 | R18 | 300 | Resistor, Chip, 1/16W, 1% | 0603 | std | std |
| 1 | R19 | OPEN | Resistor, Chip, 26.7K-Ohms, 1/16-W, 1% | 0603 | Std | Std |
| 1 | R20 | 10k | | | | |
| | R21 | 300 | Resistor, Chip, 1/16W, 1% | 0603 | std | std |
| 5 | TP1 | 5000 | Test Point, Red, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5000 | Keystone |
| 4 | TP2 | 5001 | Test Point, Black, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5001 | Keystone |
| | TP3 | 5000 | Test Point, Red, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5000 | Keystone |
| | TP4 | 5000 | Test Point, Red, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5000 | Keystone |

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|--------|---|-----------|--|--------------------|-----------|----------|--|
| | TP5 | 5000 | Test Point, Red, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5000 | Keystone | |
| | TP6 | 5001 | Test Point, Black, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5001 | Keystone | |
| | TP7 | 5001 | Test Point, Black, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5001 | Keystone | |
| | TP8 | 5001 | Test Point, Black, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5001 | Keystone | |
| | TP9 | 5000 | Test Point, Red, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5000 | Keystone | |
| 1 | U1 | TPS40200D | IC, Low Cost Sync Buck Controller | SO-8 | TPS40200D | TI | |
| 1 | U2 | NE555DR | IC, Precision Timer | SO8 | NE555DR | TI | |
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| Notes: | 1. These assemblies are ESD sensitive, ESD precautions shall be observed. | | | | | | |
| | 2. These assemblies must be clean and free from flux and all contaminants. | | | | | | |
| | Use of no clean flux is not acceptable. | | | | | | |
| | 3. These assemblies must comply with workmanship standards IPC-A-610 Class 2. | | | | | | |
| | 4. Ref designators marked with an asterisk (***) cannot be substituted. | | | | | | |
| | All other components can be substituted with equivalent MFG's components. | | | | | | |

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